



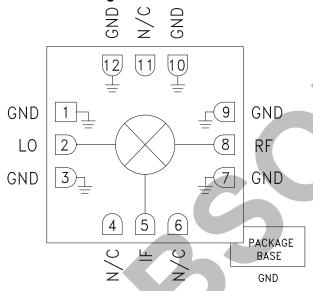
## GaAs MMIC DOUBLE-BALANCED MIXER, 2 - 18 GHz

### **Typical Application**

The HMC1048LC3B is ideal for:

- Ka-band Transponders
- · Point-to-Multi-Point Radios & VSAT
- · Test Equipment & Sensors
- · Military End-Use

#### **Functional Diagram**



#### **Features**

Passive: No DC Bias Required

High Input IP3: 23 dBm LO/RF Isolation: 38 dB LO/IF Isolation: 28 dB RF/IF Isolation: 15 dB IF Bandwidth: DC - 4 GHz

12 Lead Ceramic 3 x 3 mm SMT Package: 9 mm<sup>2</sup>

#### **General Description**

**Downconverter Applications** 

The HMC1048LC3B is a general purpose double balanced mixer that can be used as a downconverter with DC to 4 GHz at the IF port and 2 to 18 GHz at the RF port. This mixer requires no external components or matching circuitry. The HMC1048LC3B provides excellent LO/RF, LO/IF and RF/IF isolation The mixer operates with LO drive levels from +9 dBm to +17 dBm. The HMC1048LC3B eliminates the need for wire bonding and allows the use of surface mount manufacturing techniques.

## Electrical Specifications, $T_A = +25$ °C, Downconverter, IF = 100 MHz, LO = +13 dBm<sup>[1]</sup>

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, RF & LO		2 - 12		12 - 18			GHz
Frequency Range, IF	DC - 4		DC - 4			GHz	
Conversion Loss		9	12		11	13	dB
LO to RF Isolation [2]	28	38		28	35		dB
LO to IF Isolation [2]	15	20		18	28		dB
RF to IF Isolation	8	15		6	12		dB
IP3 (Input)		20			23		dBm
1 dB Gain Compression (Input)		10			13		dBm

<sup>[1]</sup> Unless otherwise noted all measurements performed as an Downconverter.

<sup>[2]</sup> Fixed IF = 100 MHz.

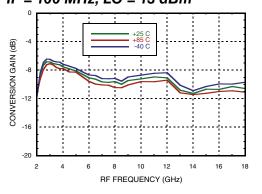
**MIXER, 2 - 18 GHz** 



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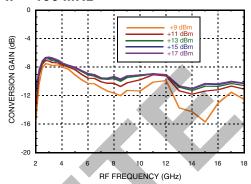


# Conversion Gain vs. Temperature, IF = 100 MHz, LO = 13 dBm

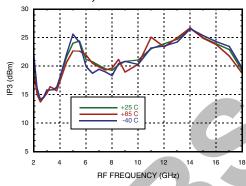


# Conversion Gain vs. LO Power, IF = 100 MHz

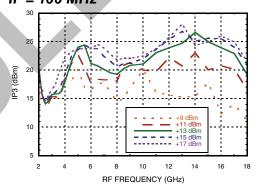
GaAs MMIC DOUBLE-BALANCED



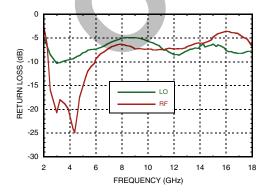
# Input IP3 vs. Temperature, IF = 100 MHz, LO = 13 dBm



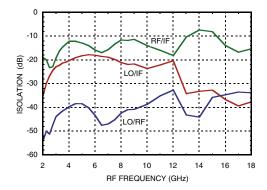
# Input IP3 vs. LO Power IF = 100 MHz



#### RF and LO Return Loss



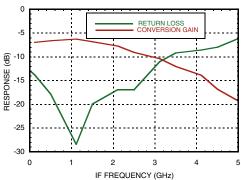
#### Isolation



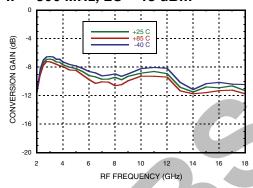




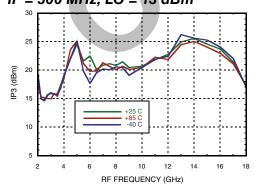
### IF Bandwidth @ LO = 13 dBm, LO = 2.4 GHz



### Conversion Gain vs. Temperature, IF = 500 MHz, LO = 13 dBm



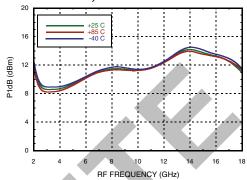
## Input IP3 vs. Temperature, IF = 500 MHz, LO = 13 dBm



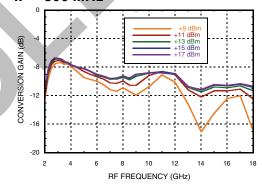
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## GaAs MMIC DOUBLE-BALANCED **MIXER, 2 - 18 GHz**

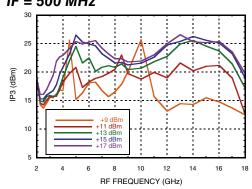
### Input P1dB vs. Temperature IF = 100 MHz, LO = 13 dBm



### Conversion Gain vs. LO Power, IF = 500 MHz



### Input IP3 vs. LO Power IF = 500 MHz

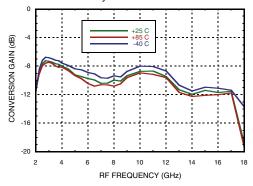




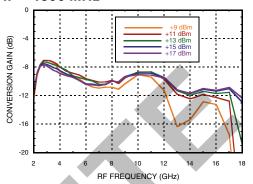


# GaAs MMIC DOUBLE-BALANCED MIXER, 2 - 18 GHz

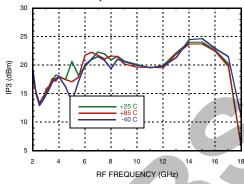
Conversion Gain vs. Temperature, IF = 1500 MHz, LO = 13 dBm



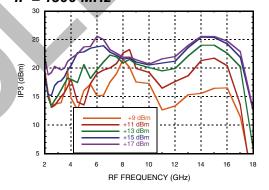
# Conversion Gain vs. LO Power, IF = 1500 MHz



# Input IP3 vs. Temperature, IF = 1500 MHz, LO = 13 dBm



# Input IP3 vs. LO Power IF = 1500 MHz







## GaAs MMIC DOUBLE-BALANCED MIXER, 2 - 18 GHz

# MxN Spurious Outputs, Downconverter

	nLO				
mRF	0	1	2	3	4
0	х	-0.5	26.8	-2.4	29.6
1	7.5	0	16.2	18.8	28.5
2	62.2	55.2	55.5	48.1	58.3
3	65	63.7	63.6	67.7	67.3
4	63.5	67.1	65.3	68.9	69.3

RF = 2 GHz @ -10 dBm LO = 2.1 GHz @ +13 dBm

All values in dBc below IF power level

# MxN Spurious Outputs, Upconverter

	nLO				
mIF	0	1	2	3	4
0	х	-10.3	16.6	15.2	29.5
1	5.4	0	26.7	24	36.3
2	55.6	39.6	52.2	39.9	52
3	65.4	60.1	57.7	63.8	64.5
4	64.6	66.7	67.1	69.8	71.7

RF = 4 GHz @ -10 dBm

LO = 4.1 GHz @ +13 dBm

All values in dBc below RF power level

#### Harmonics of LO

10 From (CUT)	nLO Spur at RF Port				
LO Freq. (GHz)	1	2	3	4	
2	60.76	45.98	58.15	56.06	
4	39.86	31.63	49.77	43.87	
6	43.29	31.08	51.66	58.58	
10	39.12	31.05	62.34	64.12	
12	32.53	42.18	32.52	70.08	
14	45.01	53.44	41.58	NA	

LO = + 13 dBm

Values in dBc below LO level measured at RF Port.





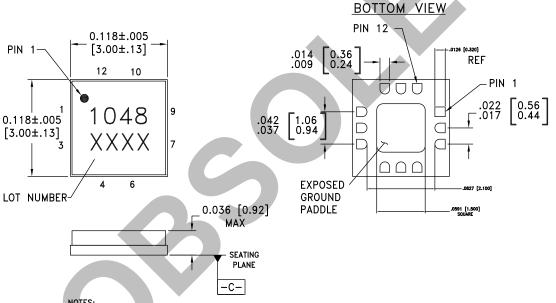
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### **Absolute Maximum Ratings**

RF / IF Input( LO = +18 dBm)	+15.5 dBm
LO Drive	+20 dBm
Max Junction Temperature @ 85°C w/ 19 dBm	116 °C
Continuous Pdiss (T = 85 °C) (derate 2.5 mW/°C above 85 °C)	165 mW
Thermal Resistance (R <sub>TH</sub> ) (junction to package bottom)	392 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-55 to +85 °C
ESD Sensitivity (HBM)	Class 1A



### **Outline Drawing**



#### NOTES:

- 1. PACKAGE BODY MATERIAL: ALUMINA
- 2. LEAD AND GROUND PADDLE PLATING: 30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL.
- 3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 5. CHARACTERS TO BE BLACK INK MARKED WITH .018"MIN to .030"MAX HEIGHT REQUIREMENTS. UTILIZE MAXIMUM CHARACTER HEIGHT BASED ON LID DIMENSIONS AND BEST FIT. LOCATE APPROX. AS SHOWN.
- 6. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM -C-
- 7. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [2]
HMC1048LC3B	Alumina, White	Gold over Nickel	MSL3 [1]	H1048 XXXX

<sup>[1]</sup> Max peak reflow temperature of 260 °C

<sup>[2] 4-</sup>Digit lot number XXXX

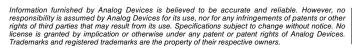




## GaAs MMIC DOUBLE-BALANCED MIXER, 2 - 18 GHz

## **Pin Descriptions**

Pin Number	Function	Description	Interface Schematic
1, 3, 7, 9, 10, 12	GND	These pins and the exposed ground paddle must be connected to RF/DC ground.	→ GND =
2	LO	This pin is matched to 50 Ohms.	LO 0-M
4, 6, 11	N/C	No connection required. These pins are not connected internally: However, all data shown herein was measured with these pins connected to ground.	
5	IF	This pin is DC coupled matched to 50 Ohms	IF O
8	RF	This pin is matched to 50 Ohms	ORF

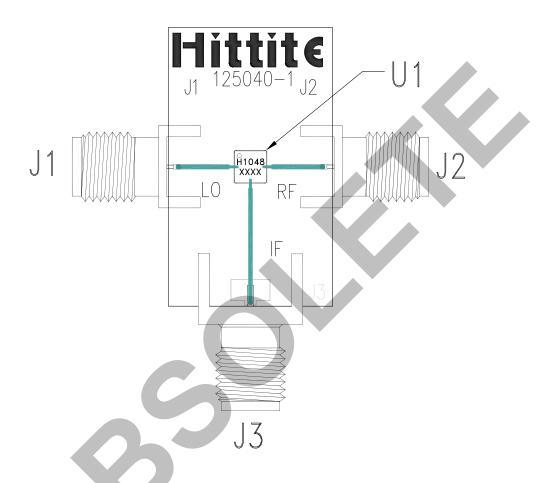






## GaAs MMIC DOUBLE-BALANCED MIXER, 2 - 18 GHz

#### **Evaluation PCB**



### List of Materials for Evaluation PCB EVAL01-HMC1048LC3B [1]

Item	Description
J1-J2	PCB Mount 2.9 mm K Connector, SRI
J3	PCB Mount SMA Connector
U1	HMC1048LC3B
PCB [2]	125040-1 Evaluation Board

<sup>[1]</sup> Reference this number when ordering complete evaluation PCB

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

<sup>[2]</sup> Circuit Board Material: Rogers 4350

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